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Name of conveying party(ies): Seiichi Nakatani Koichi Hirano Mitsuhiro Matsuo Hiroyuki Handa		Matsushita Electric Industrial Co., Ltd. 1006-banchi Oaza-Kadoma Kadoma-shi Osaka 571-8501 Japan
Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No		Additional name(s) & address(es) attached? ☐ Yes ☒ No
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If this document is being filed together w	ith a new application, th	e execution date of the application is: May 31, 2000
A. Patent Application No.(s)		B. Patent No.(s)
document should be mailed: Name: Douglas P. Mueller Address: Merchant & Gould P.C. P.O. Box 2903 Minneapolis, MN 55402-0903	23552 PATENT TRADEMARK OFFICE	 7. Total fee (37 CFR 3.41): \$40.00 Enclosed Authorized to be charged to deposit account 8. Please charge any additional fees or credit any overpayments to our Deposit account number: 13-2725
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To the best of my knowledge and belief, a priginal document. Douglas P. Mueller Name of Person Signing	DAPM	ignature Total number of pages including cover sheet, attachments, and document:
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PATENT REEL: 010877 FRAME: 0883

INSTRUCTIONS

ASSIGNMENT OF U.S. RIGHTS TO CORPORATION

WHEREAS.

Inventor(s) Name, Address, Citizenship

- 1. <u>Seiichi NAKATANI</u> residing at <u>11-29-16</u>, <u>Kourigaoka</u>, <u>Hirakata-shi</u>, <u>Osaka 573-0085</u>, <u>JAPAN</u> and a citizen of <u>JAPAN</u>;
- 2. <u>Koichi HIRANO</u> residing at 2-9-15-612, <u>Makinosaka</u>, <u>Hirakata-shi</u>, <u>Osaka 573-1146</u>, <u>JAPAN</u> and a citizen of <u>JAPAN</u>;
- 3. <u>Mitsuhiro MATSUO</u> residing at 2-2-2-518, <u>Minamiterakatakitadori</u>, <u>Moriguchi-shi</u>, <u>Osaka 570-0046</u>, <u>JAPAN</u> and a citizen of <u>JAPAN</u>;
- 4. Hiroyuki HANDA residing at 19-8, Higashikourishinmachi, Hirakata-shi, Osaka 573-0077, JAPAN and a citizen of JAPAN;

Date Patent Declaration Signed and Title Serial No. and filing date (if known) (herein called "THE UNDERSIGNED") have made an invention and have executed an application for Letters Patent of the United States on for this invention, which application is entitled

POWER MODULE AND METHOD OF MANUFACTURING THE SAME

and which has been given Serial Number		and the filing
date of	;	

Name of Corporation

AND WHEREAS <u>Matsushita Electric Industrial Co., Ltd.</u> (herein called "ASSIGNEE"), a corporation organized under the laws of <u>JAPAN</u>, and having an office and place of business at <u>1006-banchi</u>, <u>Oaza-Kadoma</u>, <u>Kadoma-shi</u>, <u>Osaka 571-8501</u>, <u>JAPAN</u>

State or Country of Incorporation and Address

wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign and transfer to the ASSIGNEE, its successors and assigns, the entire right, title and interest for the United States in and to the invention disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents to issue any and all United States Letters Patent for the aforesaid invention to the ASSIGNEE of the entire right, title and interest in and to the same, for the use of the ASSIGNEE, its successors and assigns.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to THE UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, its successors or assigns the entire right, title and interest in and to the said invention, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE its successors and assigns, that no assignment grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by THE UNDERSIGNED, and that full right to convey the same as

PATENT REEL: 010877 FRAME: 0884 herein expressed is possessed by THE UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Each inventor must sign & date

Note: No legalization or other witness required

Signature

RECORDED: 06/06/2000

PATENT REEL: 010877 FRAME: 0885